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ON Semiconductor®

N-Channel SuperFET[®] III MOSFET 650 V, 24 A, 125 m Ω

FCPF125N65S3

Features

- 700 V @ T_J = 150 °C
- Typ. R_{DS(on)} = 105 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 44 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 405 pF)
- 100% Avalanche Tested
- RoHS Compliant

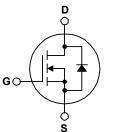
Applications

- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies



SuperFET[®] III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SuperFET III MOSFET is very suitable for various power system for miniaturization and higher efficiency.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCPF125N65S3	Unit			
V _{DSS}	Drain to Source Voltage			650	V	
V _{GSS}		- DC		±30	V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		24*	^	
	Drain Current	- Continuous (T _C = 100 ^o C)		15*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	60*	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			115	mJ	
I _{AS}	Avalanche Current (Note 1)			3.7	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.38	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
P _D	Dower Dissinction	(T _C = 25°C)		38	W	
	Power Dissipation	- Derate Above 25°C		0.31	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

*Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FCPF125N65S3	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.24	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	- C/VV	

FCPF125N65S
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Channel SuperFET [®]
III MOSFET

		Top Mark	Package	Packing Method	Reel Size	ə 1	Tape Width	Qu	antity
		TO-220F			N/A		50 units		
Electrica	al Chara	icteristics T _C = 25	^o C unless oth	erwise noted.					
Symbol		Parameter		Test Condition	S	Min.	Тур.	Max.	Unit
Off Chara	cteristics	i							
BV _{DSS}	Drain to Source Breakdown Voltage			V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C V_{GS} = 0 V, I_D = 1 mA, T_J = 150°C		650 700	-	-	V
ΔBV _{DSS} / ΔΤ.Ι	Breakdown Voltage Temperature Coefficient			$I_D = 1$ mA, Referenced to 25°C		-	0.65	-	V/ºC
	Zero Gate Voltage Drain Current		VD	$V_{DS} = 650 V, V_{GS} = 0 V$ $V_{DS} = 520 V, T_{C} = 125^{\circ}C$		-	-	1	1 - μA
DSS			VD			-	1.29	-	
I _{GSS}	Gate to Body Leakage Current			V_{GS} = ±30 V, V_{DS} = 0 V			-	±100	nA
On Chara	cteristics								
V _{GS(th)}	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D} = 2.4 \text{ mA}$		2.5	-	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance			$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}$		-	105	125	mΩ
9FS	Forward Transconductance			$V_{\rm DS} = 20 \text{ V}, \text{ I}_{\rm D} = 12 \text{ A}$			16	-	S
	Character	ristics							1
	Characteristics Input Capacitance V _{DS} = 400 V, V _{CS} = 0 V,					_	1790	_	pF
C _{oss}	Output Capacitance			$V_{DS} = 400 V, V_{GS} = 0 V,$ f = 1 MHz $V_{DS} = 0 V \text{ to } 400 V, V_{GS} = 0 V$			40	_	pF
	Effective Output Capacitance					_	405		pF
Coss(eff.)	Energy Related Output Capacitance			$V_{\rm DS} = 0 V \text{ to } 400 V, V_{\rm GS} = 0 V$ $V_{\rm DS} = 0 V \text{ to } 400 V, V_{\rm GS} = 0 V$		_	60	_	pF
C _{oss(er.)}		e Charge at 10V			0 0	-	44	_	nC
Q _{g(tot)} Q _{gs}		ource Gate Charge		_{DS} = 400 V, I _D = 12 A, _{DS} = 10 V	_	-	12	_	nC
Q _{gd}		Prain "Miller" Charge	• (.		(Note 4)		12	-	nC
ESR		nt Series Resistance	f =	1 MHz	. ,	-	4	_	Ω
			•						
Switching		Delay Time				-	22		ne
t _{d(on)}		Rise Time	Va	_D = 400 V, I _D = 12 A,		-	22	-	ns
t _r		Delay Time		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$		-	60	-	ns ns
t _{d(off)} t _f	Turn-Off F			g g	(Nata 4)	-	15	-	ns
					(Note 4)	-	15	_	115
	1	e Characteristics				-	1 1		
l _S		Continuous Source to I					-	24	A
I _{SM}		Pulsed Source to Drain	I.			-	-	60	A
V _{SD}		Source Diode Forward V	-	$_{\rm S} = 0 \text{ V}, \text{ I}_{\rm SD} = 12 \text{ A}$		-	-	1.2	V
t _{rr}		Recovery Time		_S = 0 V, I _{SD} = 12 A, //dt = 100 A/μs	F	-	362	-	ns
Q _{rr}	Reverse F	Recovery Charge	ur	/ut = 100 A/µs		-	6.36	-	μC

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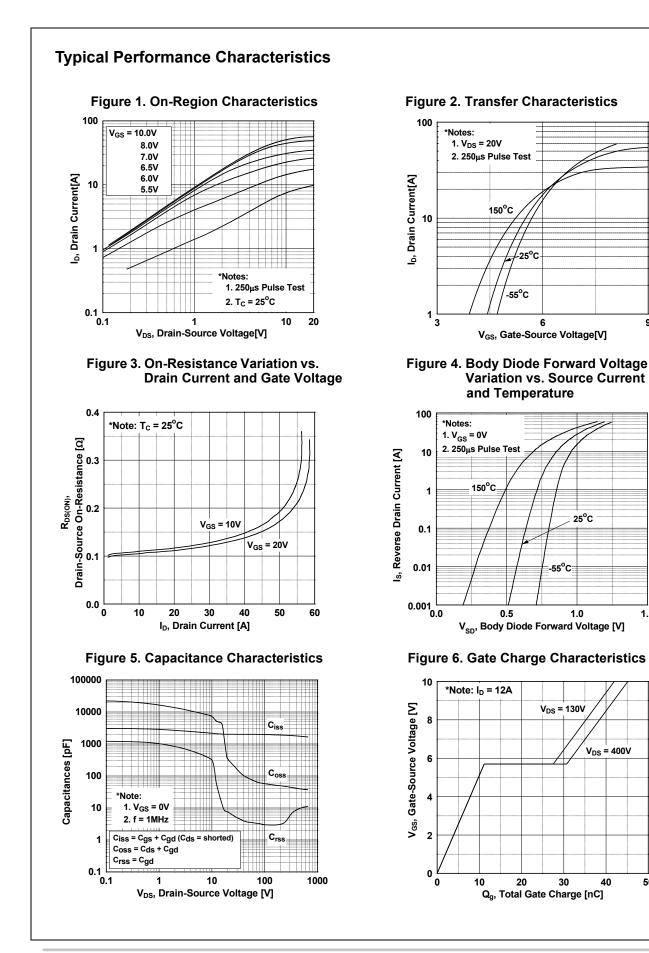
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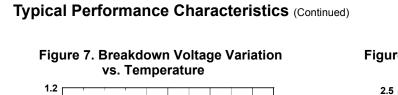
V_{DS} = 400V

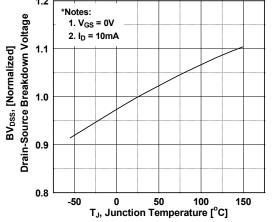
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25°C



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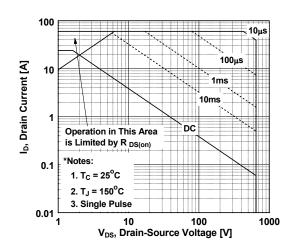
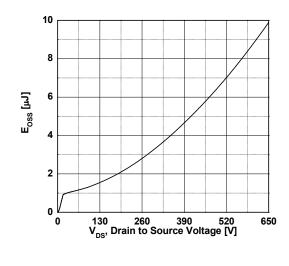
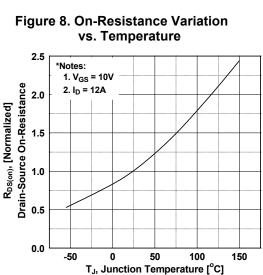
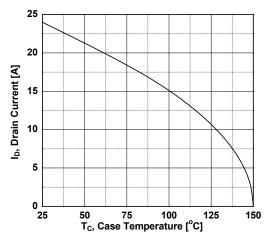


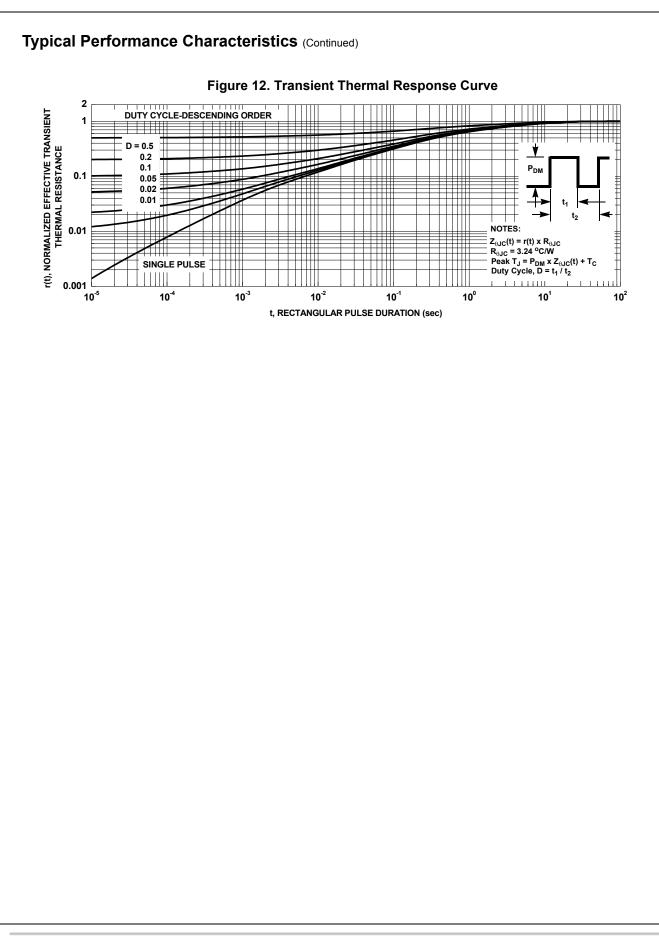
Figure 11. Eoss vs. Drain to Source Voltage

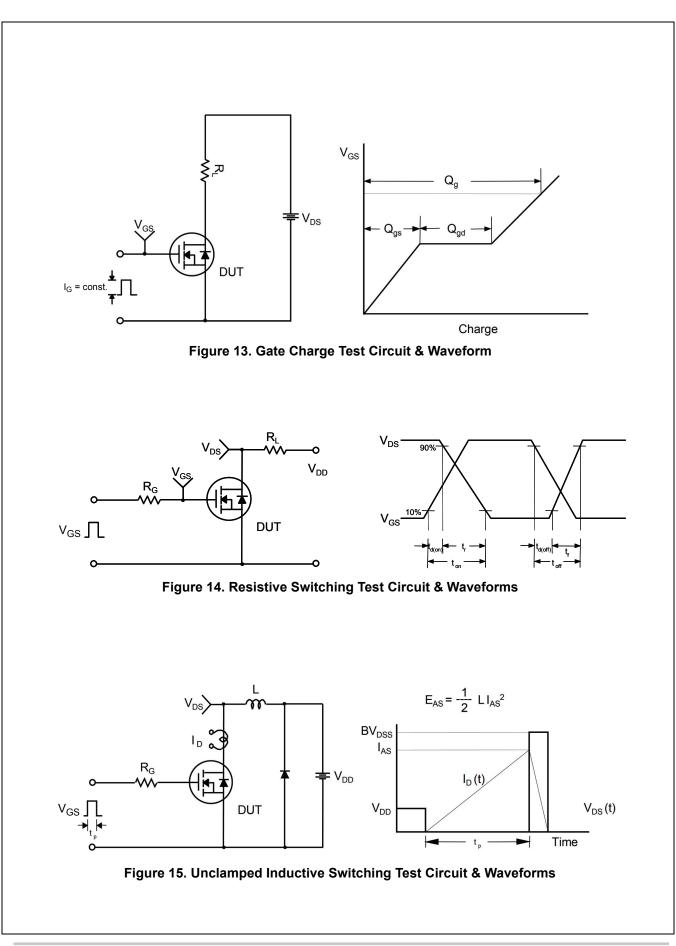




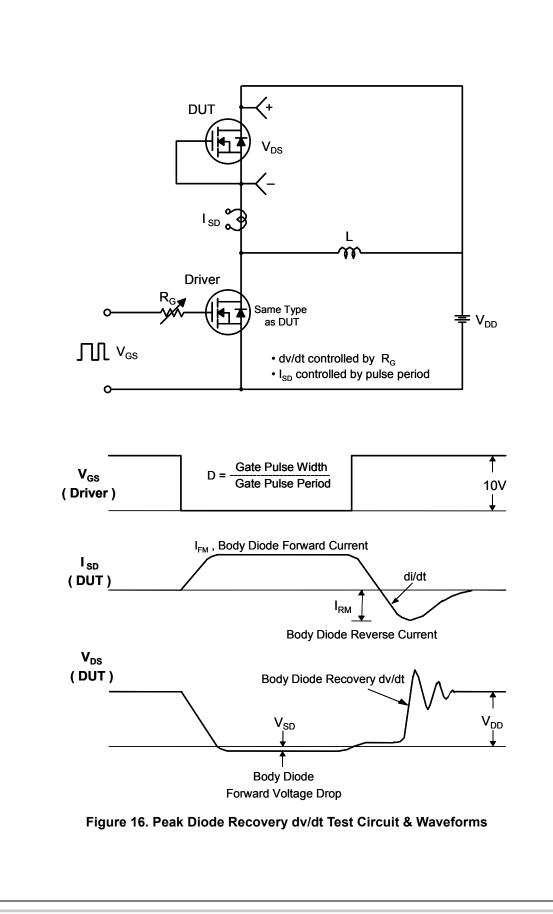


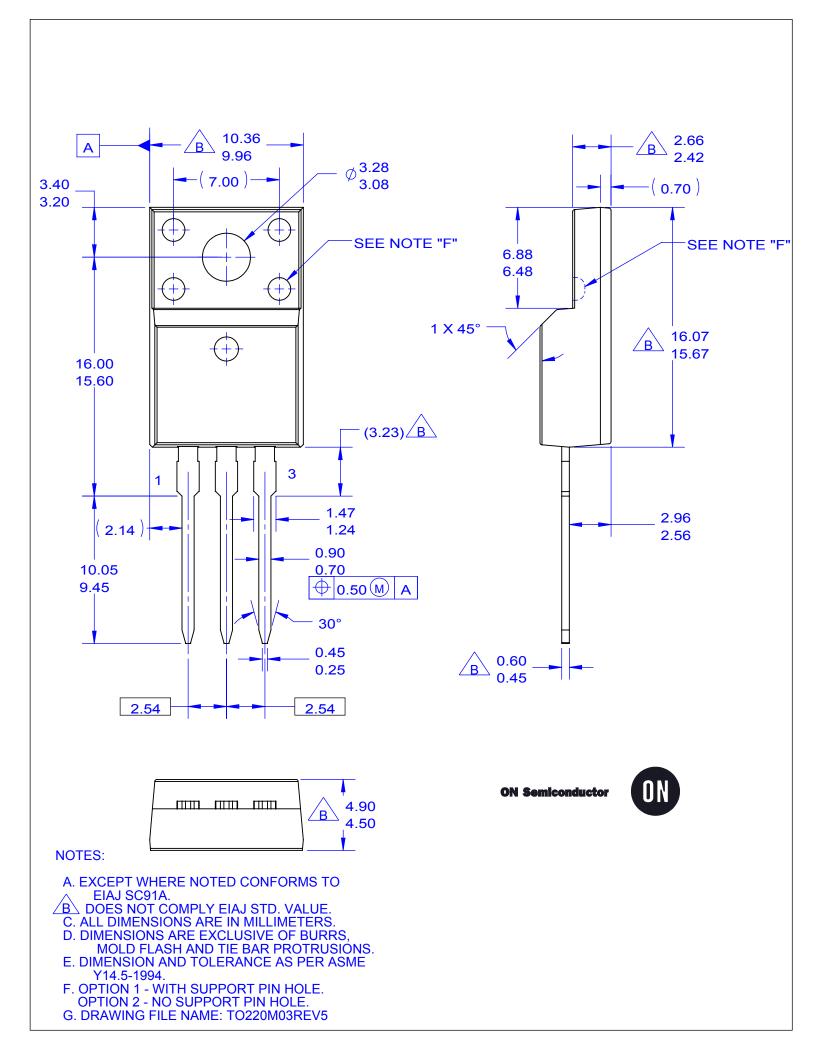






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